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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/989,250	11/20/2001	Robertus Mominicus Joseph Verhaar	NL 000627	9630

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Corporate Patent Counsel
U.S. Philips Corporation
580 White Plains Road
Tarrytown, NY 10591

11/21/00

EXAMINER

LUU, CHUONG A

ART UNIT PAPER NUMBER

2825

DATE MAILED: 11/06/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

09/989,250

Applicant(s)

VERHAAR ET AL.

Examiner

Chuong A Luu

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 03 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☐ Responsive to communication(s) filed on ____.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-6 is/are pending in the application.
- 4a) Of the above claim(s) ____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) ____ is/are allowed.
- 6) ☒ Claim(s) 1-6 is/are rejected.
- 7) ☐ Claim(s) ____ is/are objected to.
- 8) ☐ Claim(s) ____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on ____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on ____ is: a) ☐ approved b) ☐ disapproved by the Examiner.
- If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

Priority under 35 U.S.C. §§ 119 and 120

- 13) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All b) ☐ Some * c) ☐ None of:
1. ☒ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. ____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- * See the attached detailed Office action for a list of the certified copies not received.
- 14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).
- a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☒ Information Disclosure Statement(s) (PTO-1449) Paper No(s) 3, 6.
- 4) ☐ Interview Summary (PTO-413) Paper No(s). ____.
- 5) ☐ Notice of Informal Patent Application (PTO-152)
- 6) ☐ Other:

DETAILED ACTION

Specification

The disclosure is objected to because of the following informalities: The titles is missing in the body of specification as: technical field; background of the invention; summary of invention; brief description of the drawings; detailed description of the invention. Appropriate correction is required.

PRIOR ART REJECTIONS

Statutory Basis

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

The Rejections

Claims 1-6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Freiberger et al. (U.S. 5,104,819) in view of Naito et al. (6,472,259 B1)

Freiberger discloses a method of fabrication of interpoly dielectric for EPROM-related technologies with

(1) a substrate having a patterned ONO insulating layer over a portion thereof, and characterized by the steps of forming an insulating layer comprising an Oxide-Nitride-Silicon layered structure on the substrate, subsequently re-oxidizing the silicon

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layer of the remaining Oxide-Nitride-Silicon structure so as to form an ONO insulating layer structure (see column 2, lines 30-51);

(3) wherein a non-volatile memory cell is applied as part of the semiconductor structure, which non-volatile memory cell employs the ONO insulating layer between a floating gate and control gate thereof (see column 5, lines 27-62);

(6) wherein the silicon layer is re-oxidized into a thermal oxide (see column 4, lines 44-45).

Freiberger teaches the above outlined features except for applying a photoresist to the silicon surface as part of a patterning process and stripping the photoresist once a required patterning process has been completed. However, Naito discloses a method for manufacturing a semiconductor device with (1)... applying a photoresist to the silicon surface as part of a patterning process and stripping the photoresist once a required patterning process has been completed (see column 7, lines 55-64). It would have been obvious to one having ordinary skill in the art at the time of the invention was made to combine the above teachings to fabricate a semiconductor device to exceed its performance criteria.

Claim 2 is rejected under 35 U.S.C. 103(a) as being unpatentable over Freiberger et al. (U.S. 5,104,819) in view of Naito et al. (6,472,259 B1) and further in view of Cohen (U.S. 5,572,050)

Freiberger and Naito disclose everything above except for wherein the silicon layer comprises an amorphous silicon layer. Furthermore, Cohen discloses fuse-

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triggered antifuse with (2) wherein the silicon layer comprises an amorphous silicon layer (see column 4, lines 27-33). It would have been obvious to one having ordinary skill in the art at the time of the invention was made to combine the above teachings to fabricate a semiconductor device to exceed its performance criteria.

Claims 4-5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Freiberger et al. (U.S. 5,104,819) in view of Naito et al. (6,472,259 B1) and further in view of Shin et al. (U.S. 6,180,457 B1)

Freiberger and Naito disclose everything above except for wherein a non-volatile memory cell is applied with a control gate formed from a conductive layer which also serves to form part of a peripheral semiconductor structure; wherein the subsequent oxidation of the silicon sub-layer of the Oxide-Nitride-Silicon insulating layer takes place also to provide a high voltage oxide layer for a peripheral structure. Furthermore, Shin discloses a method of manufacturing non-volatile memory device with (4) wherein a non-volatile memory cell is applied with a control gate formed from a conductive layer which also serves to form part of a peripheral semiconductor structure (see column 6, lines 47-56); (5) wherein the subsequent oxidation of the silicon sub-layer of the Oxide-Nitride-Silicon insulating layer takes place also to provide a high voltage oxide layer for a peripheral structure (see column 6, lines 47-56). It would have been obvious to one having ordinary skill in the art at the time of the invention was made to combine the above teachings to fabricate a semiconductor device to exceed its performance criteria.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Freiburger et al., Naito et al., Shin et al. and Cohen et al. disclose a method of fabrication of interpoly dielectric for EPROM-related technologies.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Chuong A Luu whose telephone number is (703)305-0129. The examiner can normally be reached on M-F (7:30-4:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith can be reached on (703)308-1323. The fax phone numbers for the organization where this application or proceeding is assigned are (703)872-9318 for regular communications and (703)872-9319 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703)308-0956.

CAL
November 4, 2002



MATTHEW SMITH
SUPERVISOR/PATENT EXAMINER
TECHNOLOGY CENTER 2000